



DDR400 UNBUFFERED SO-DIMM

512MB 32x16

DESCRIPTION:

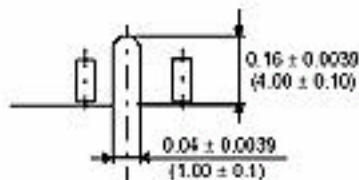
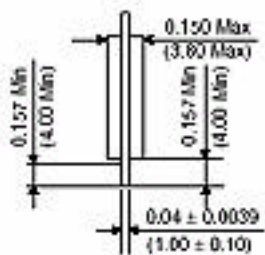
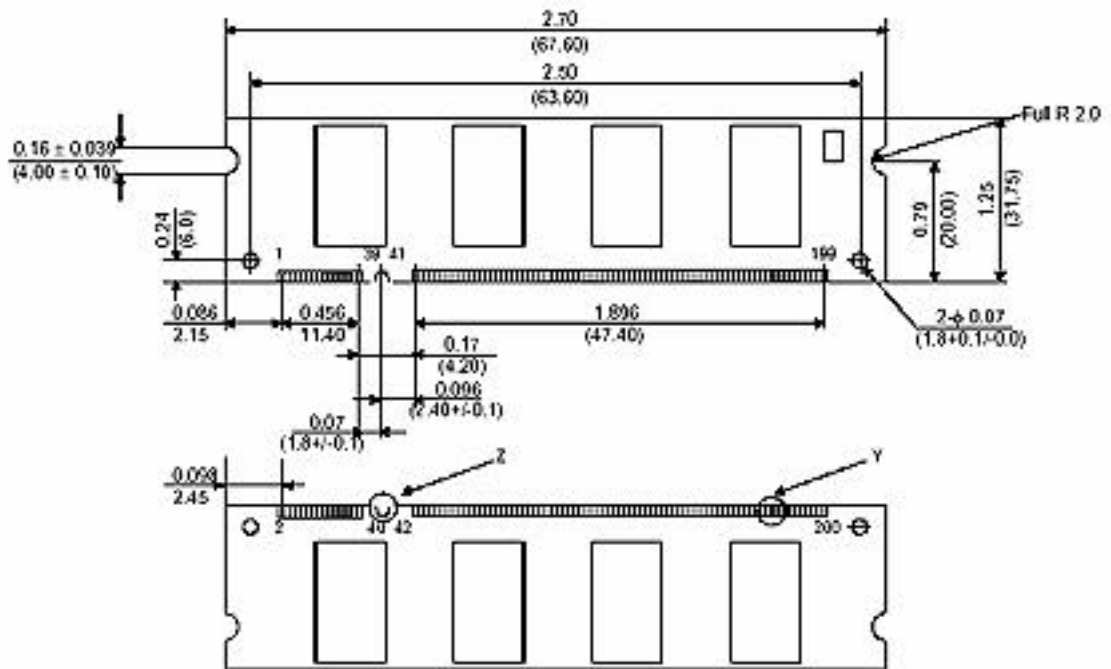
This document describes Aplus 64M x 64-bit 512MB DDR400 CL3 SDRAM (Synchronous DRAM) memory module. The components on this module include eight 32M x 16-bit (4Banks) DDR400 SDRAM in TSOP packages. This 200-pin SO-DIMM uses gold contact fingers and requires +2.6V. The electrical and mechanical specifications are as follows:

FEATURES:

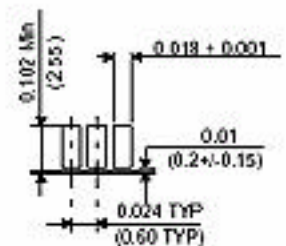
- Power supply: Vdd: 2.6V ±0.1, Vddq: 2.6V ±0.1V
- Max clock Freq: 200Mhz
- Double-data-rate architecture; two data transfers per clock cycle
- Bidirectional data strobe (DQS)
- Differential clock inputs (CK and CK)
- DLL aligns DQ and DQS transition with CK transition
- Programmable Read latency 3 (clock)
- Programmable Burst length (2,4,8)
- Programmable Burst type (sequential & interleave)
- Timing Reference: CL-tRCD-tRP (3-3-3)
- Edge aligned data output, center aligned data input
- Auto & Self refresh, 7.8us refresh interval (8K/64ms refresh)
- Serial presence detect with EEPROM
- PCB : Height 1.250 " (31.75mm), double sided component

PERFORMANCE:

Clock Cycle Time (tCK)	5ns (min.) /10ns (max.)
Row Cycle Time (tRC)	55ns (min.)
Refresh Row Cycle Time (tRFC)	70ns (min.)
Row Active Time (tRAS)	40ns (min.) /70,000ns (max.)
Power Dissipation	12W
UL Rating	94 V – 0
Operating Temperature	0 to 70
Storage Temperature	-55 to +150



Detail Z



Detail Y